

RoHS

COMPLIANT HALOGEN

FREE

**Vishay Siliconix** 

### P-Channel 20 V (D-S) MOSFET

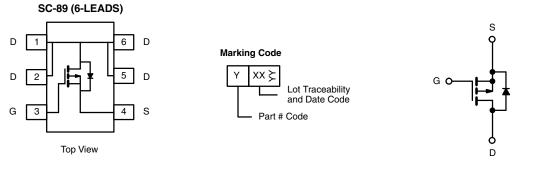
PRODU	DUCT SUMMARY			
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)	
- 20	0.184 at V <sub>GS</sub> = - 4.5 V	- 0.94	4.23	
- 20	0.268 at V <sub>GS</sub> = - 2.5 V	- 0.78	4.20	

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

• Load Switch for Portable Devices



Ordering Information: Si1069X-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>A</sub> = 25 °C, unle	ess otherwise	e noted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub> - 20		v	
Gate-Source Voltage		V <sub>GS</sub>	± 12	v	
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	1-	- 0.94 <sup>b, c</sup>		
Continuous Drain Current (1) = 150°C)	T <sub>A</sub> = 70 °C	I <sub>D</sub>	- 0.75 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	- 8		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	۱ <sub>S</sub>	- 0.2 <sup>b, c</sup>		
Marian Distribution	T <sub>A</sub> = 25 °C	P <sub>D</sub> 0.236 <sup>b, c</sup>		W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	·D	0.151 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	ange	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum lumetice to Archienta b	t ≤ 5 s	R <sub>thJA</sub>	440	530	°C/W
Maximum Junction-to-Ambient <sup>a, b</sup>	Steady State	' 'thJA	540	650	0/10

Notes:

a. Based on  $T_A$  = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

## Si1069X

## Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A		- 16.7		m\//°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	l <sub>D</sub> = - 250 μA		2.95		- mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.6		- 1.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zava Cata Valtaga Drain Current	I	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 85 °C			- 10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS}$ = $\geq$ 5 V, $V_{GS}$ = - 4.5 V	- 8			А	
	В	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 0.94 A	0.153		0.184	0	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 0.78 A		0.218	0.268	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 0.94 A		4		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			308		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = - 10 V, $V_{GS}$ = 0 V, f = 1 MHz		78			
Reverse Transfer Capacitance	C <sub>rss</sub>			59			
Tatal Cata Charge	0	$V_{DS} = -10$ V, $V_{GS} = -5$ V, $I_{D} = -0.94$ A		4.57	6.86		
Total Gate Charge	Qg			4.23	6.35		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 10 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 0.94 A		0.71		- nC	
Gate-Drain Charge	Q <sub>gd</sub>			1.67			
Gate Resistance	Rg	f = 1 MHz		9	13.5	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			19	28.5		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 13.3 $\Omega$		31	47	- ns	
Turn-Off DelayTime	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 0.75 A, $\text{V}_\text{GEN}$ = - 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		23	34.5		
Fall Time	t <sub>f</sub>			7	10.5		
Drain-Source Body Diode Characteris	stics						
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				8	Α	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 0.64 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			19	28.5	nC	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = -0.64  A  d/d = 100  A/us		6.65	10		
Reverse Recovery Fall Time	t <sub>a</sub>	l <sub>F</sub> = - 0.64 A, dl/dt = 100 A/μs		7		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			12			

Notes:

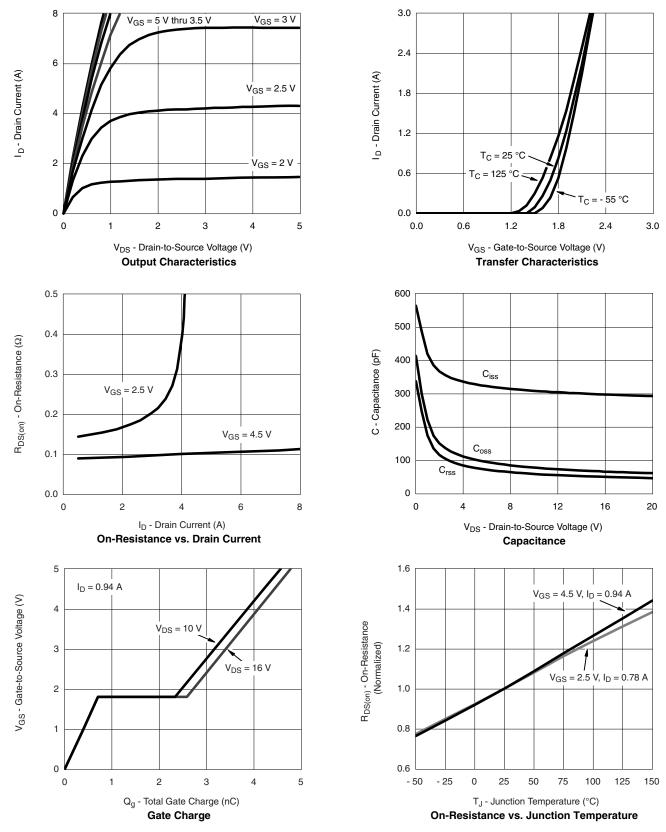
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



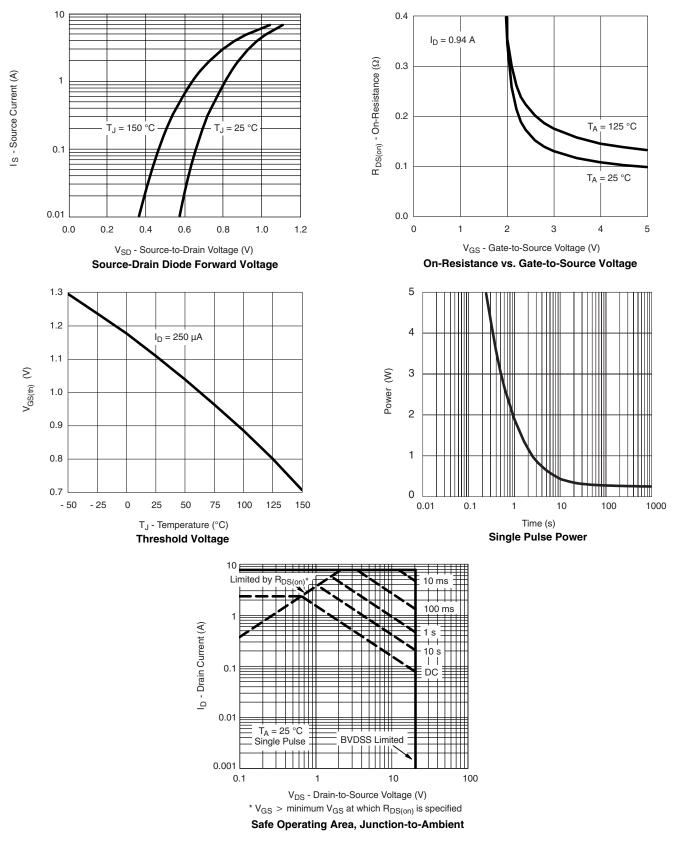
Document Number: 70442 S10-2542-Rev. C, 08-Nov-10

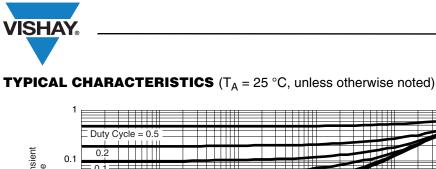
### Si1069X

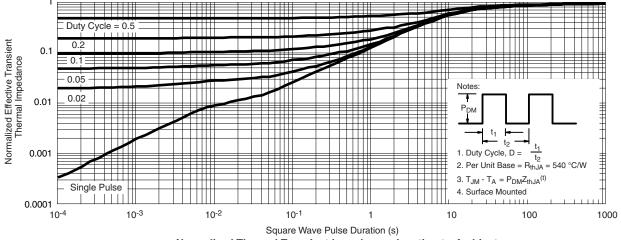
### Vishay Siliconix



#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)







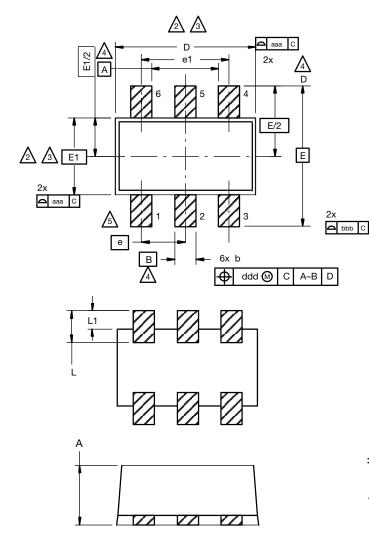
Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?70442.



Vishay Siliconix

### SC-89 6-Leads (SOT-563F)



Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

A Datums A, B and D to be determined 0.10 mm from the lead tip.

 $\triangle$  Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.









DIM.	MILLIMETERS				
	MIN.	NOM.	MAX.		
А	0.56	0.58	0.60		
A1	0	0.02	0.10		
b	0.15	0.22	0.30		
С	0.10	0.14	0.18		
D	1.50	1.60	1.70		
E	1.50	1.60	1.70		
E1	1.15	1.20	1.25		
е	0.45	0.50	0.55		
e1	0.95	1.00	1.05		
L	0.25	0.35	0.50		
L1	0.10	0.20	0.30		
C14-0439-Rev DWG: 5880	v. C, 11-Aug-14				

Revision: 11-Aug-14

1 For technical questions, contact: <u>analogswitchtechsupport@vishay.com</u> Document Number: 71612

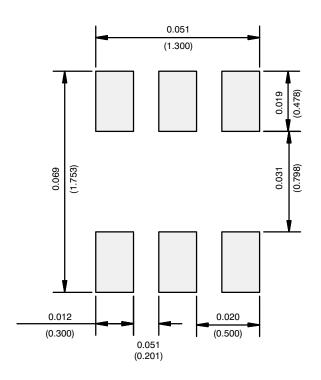
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000



# Application Note 826

Vishay Siliconix

#### **RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

### Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

### **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.